Practitioner's Docket No. MI22-981



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Farnworth et al, Warren M.

Serial No.: 09/148,723

Group No.: 3729

Filed: 09/03/1998

Examiner: Not Assigned

For: Methods of Bonding Solder Balls to Bond Pads on a Substrate, and Bonding Frames

Assistant Commissioner for Patents

Washington, D.C. 20231

REQUEST FOR CORRECTED FILING RECEIPT

- 1. Attached is a copy of the official filing receipt received from the PTO in the above application for which issuance of a corrected filing receipt is respectfully requested.
- 2. There is an error with respect to the following, which is incorrectly entered.

RECEIVED

JAN 1 1 1999

TECHNOLOGY CENTER 3700

CERTIFICATE OF MAILING/TRANSMISSION (37 C.F.R. 1.8a)

I hereby certify that this correspondence is, on the date shown below, being:

MAILING

deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Date: 12/2/98

FACSIMILE

transmitted by facsimile to the Patent and Trademark Office.

Signature

(type or print name of person certifying)

(Request for Corrected Filing Receipt-page 1 of 4)

Error in

Correct data

1. Filing Date

1. 09/03/1998

3. The correction is not due to any error by applicant and no fee is due.

SIGNATURE OF PRACTITIONER

Lance R. Sadler Reg. No.: 38605

Customer No.: 021567

Wells, St. John, Roberts, Gregory & Matkin, P.S.

601 West First Ave., Suite 1300 Spokane, WA 99201-3828 Tel. No.: (509) 624-4276

U.S.A.

PTO-103X (Rev. 7-93)

CORRECTED 2



UNITED STATES DEPARTMENT OF COMMERCE Patent and Trademark Office ASSISTANT'SECRETARY AND COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

APPLICATION NUM	BER FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTORNEY DOCKET NO.	DRWGS	TOT CL	IND CL
	3 09/04/98		\$1,858.00		3	44	8

09/03/98
021567
WELLS ST JOHN ROBERTS GREGORY & MATKIN
601 W FIRST AVE
SUITE 1300
SPOKANE WA 99201-3817

Receipt is acknowledged of this patent application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Application Processing Division's Customer Correction Branch within 10 days of receipt. Please provide a copy of the Filing Receipt with the changes noted thereon.

Applicant(s)

WARREN M. FARNWORTH, NAMPA, ID; ALAN G. WOOD, BOISE, ID.

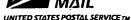
FOREIGN FILING LICENSE GRANTED 09/23/98
TITLE
METHODS OF BONDING SOLDER BALLS TO BOND PADS ON A SUBSTRATE, AND BONDING FRAMES

PRELIMINARY CLASS: 029

COPY FOR YOUR INFORMATION

ELIPURBALIA







POST OFFICE TO ADDRESSEE

ORIGIN (POSTAL USE C	NLY) Said of the said of	9 71 . 42
PO ZIP Code	Day of Delivery	Flat Rate Envelope
99202	Next Second	
Date in		Postage
98 very 3	12 Noon 3 PM	s/0 75
Time in 1750	Multbary 2nd Day 3rd Day	Return Receipt Fee
Weight 7 ozs.	Int'l Alpha Country Code	COD Fee Insurance Fee
No Delivery Weekand Holiday	Acceptance Clerkfinhtials	S 10.75

SEE REVERSE SIDE FOR SERVICE GUARANTEE AND LIMITS ON INSURANCE COVERAGE

COPY FOR YOUR

CUSTOMER USE ONLY METHOD OF PAYMENT: Express Mail Corporate Acct. No. Federal Agency Acct. No. or Postal Service Acct. No.	4905335	wish defuse	ry to be made without obtaining: an be left in secure location) and	Audjubrai ingrubendsa ingrupenda vid Japanuta priadriessen y laduressen s I aumoros ingruben y prindones gis Customer Signatur	orative constitues valor proof
FROM: (PLEASE PRINT)	PHONE 509 , 624-4276		TO: (PLEASE PRONT)	PHONE ()	
GREGGRY STORESTORE	CHN ACHERTS MATRIX AVE STE 1300 FMA 4920)1-3828		LICATION Commissioner for D.C. 20231	r Patents
LRS/mjk	MI22-981	٦	L	1/4.	

09/03/98

The stamp of the U.S. Patent and Trademark Office acknowledges receipt of the application for letters patent of the following:

Warren M. Farnworth et al.

"Methods of Bonding Solder Balls to Bond Pads on a

Substrate, and Bonding Frames"

Return Postcard Receipt 1.

PTO Utility Patent Application Transmittal 2ω

Title page, plus 20 total Specification, Claims and Abstract pages (Claims 1-44)

Unexecuted Declaration

sheets of formal drawings (Figs. 1-7)



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

			• • •		
	ATTORNEY'S DOCKET N	Ю	d Pads on a Substrate, an	MI22-981	
	EX PO	OST DECLARATION	OF EXPRESS MAILING		
61	"Express Mail Post Office to Ad 37 CFR 1.10. The Express M	Idressee" service, addresse [ail label No. has been [ail 1 6 9 8]	olaced on one or more of t 334996	low, in compliance with	
	Date of Denos	sit: Septem	per 3, 1998		
DEC. O	7 1998 Time of Depo			WEDD VOIL	
	Time of Depo			MMOR YOU	
n.		■ Delivery to Postal □ Placed in Drop Box	Employee		
T& TRA	IDEMATI	-	` lais	oramation	
	Addressee: Bo	X PATENT APPLICATI		al diam's i. Loid	
	_	Assistant Commissioner Washington, D.C. 2023			
		Washington, D.C. 2023	L		
	Place of Deposit:				
	U.S. Post Office (Paulsen 421 West Riverside, Room Spokane, Washington 9920 Last Scheduled Drop Box	201)1	U.S. Post Office (Terminal 703 East Trent Spokane, Washington 9920 Last Scheduled Drop Box	02	
	☐ U.S. Post Office (Riverside	Ctation)			
	904 West Riverside	Station)	U.S. Post Office	Branch	
	Spokane, Washington 9920	11			
	Last Scheduled Drop Box	Pickup: 5:00 pm	Last Scheduled Drop Box	Pickup: am/pm	
		- 1011cp : 5100 pm	East Scheduled Drop Box	i icaup am/pm	
	Listing Of Items Enclosed In	Mailing:			
	 Return Postcard Receipt PTO Utility Patent Application Title page, plus 20 total State Unexecuted Declaration 3 sheets of formal drawing 	pecification, Claims and Abs	tract pages (Claims 1-44)		
	I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 100 of Title 18 of the United States Code and that such willful false statement may jeopardize the validity of the application or any patent issued therefrom.				
	Dated this 3rd day of	September	, 19 <u>98</u>		
	Dated at <u>Spok</u>	ane		, Washington	
			_		
			Jane	O'Hare	
			(Signature)		
			JoAnne O'Hare		
			(Typed/Printed Name)		